

**UNITED STATES PATENT AND TRADEMARK OFFICE
CERTIFICATE OF CORRECTION**

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PATENT NO. : 6,919,625 B2
APPLICATION NO. : 10/617,343
ISSUE DATE : July 19, 2005
INVENTOR(S) : Paddy O'Shea et al

It is certified that an error appears or errors appear in the above-identified patent and that said Letters Patent is hereby corrected as shown below:

Abstract, line 1, before "multi-chip", change "surface mountable" to -- surface-mountable--.

Abstract, line 2, after "lead", change "frames" to -- frame--.

Specification Col. 1, line 6, before "devices", change "multichip" to -- multi-chip--.

Specification, Col. 1, line 26, after "bending", delete -- lead regions--.

Specification, Col. 1, line 34, before "surface-mount", change "multichip" to -- multi-chip--.

Specification, Col. 1, line 35, after "need", insert -- to--.

Specification, Col. 1, line 39, after "invention", insert -- ,--.

Specification, Col. 1, line 49, after "connection", insert -- with--.

Specification, Col. 3, line 28, after "multi-chip", change "devices" to -- device--.

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Specification Col 3, line 59, after "surface-mount", change "multichip" to -- multi-chip--.

Specification, Col. 3, line 60, after "present", change "inveniton" to -- invention--.

Specification Col. 4, line 2, after "surface-mount", change "multichip" to -- multi-chip--.

Specification, Col. 4, line 3, after "present", change "inveniton" to -- invention--.

Specification, Col 4, line 5, after "surface-mount", change "multichip" to -- multi-chip--.

Specification, Col. 4, line 6, after "present", change "inveniton" to -- invention--.

Specification, Col. 4, line 17, after "present", change "inveniton" to -- invention--.

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Specification Col 4, line 19, after "surface-mount", change "multichip" to -- multi-chip--.

Specification, Col. 4, line 20, after "present", change "inveniton" to -- invention--.

Specification, Col. 4, line 21, after "view", insert -- of--.

Specification, Col. 4, line 22, after "present", change "inveniton" to -- invention--.

Specification, Col. 5, line 13, after "laterally", change "outwardly" to -- outward--.

Specification, Col. 5, line 23, after "power", change "handing" to -- handling--.

Specification, Col. 5, line 35, before "structure", change "surface mount" to -- surface-mount--.

Specification, Col. 5, line 65, after "that", change "were" to -- where--.

Specification, Col. 6, line 1, before "where", change " C_{net} C_{RD} " to -- $C_{\text{net}} = C_{\text{RD}}$ --.

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Specification, Col. 6, line 50, after "this", change "types" to -- type--.

Specification, Col. 6, line 52, before "clamps", change "devices" to -- device--.

Specification, Col. 6, line 66, after "are", change "surface mount" to -- surface-mount--.

Specification, Col. 7, line 23, after "regions.", change "}" to -- }--.

Specification, Col. 7, line 57, after "lower", change "that" to -- than--.

Specification, Col. 8, line 11, after "Low-capacitance.", change "two-leaded" to -- two-lead--.

Specification, Col. 8, line 13, before "packages", change "surface mount" to -- surface-mount--.

Specification, Col. 8, line 16, after "either", delete -- in--.

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Specification, Col. 8, line 17, after "or", insert -- a--.

Specification, Col. 8, line 36, after "each", change "another" to -- other--.

Specification, Col. 8, line 67, after "completely", change "encapsulates" to --
encapsulate--.

Claim 1, Col. 9, line 38, after "connection", insert -- with--.

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